

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: PENDSE et al.

Application No.: 09/802,433

Filed: March 9, 2001

Title: Flip chip-in-leadframe

package and process

Attorney Docket No.: CPAC 1001-1US

(formerly 60884-300101)

Examiner: Unknown

Group: 2811

## PETITION FOR EXTENSION OF TIME

Commissioner of Patents Washington, D.C. 20231

Dear Sir:

Applicant requests three months extension of time, up to and including September 19, 2001, in which to respond to the Notice to File Missing Parts of Nonprovisional Application-Filing Date Granted mailed on April 19, 2001.

The appropriate extension fee of \$890.00 is enclosed. Should it be determined that additional fees are required, the Commissioner is hereby authorized to charge those fees to Deposit Account No. 50-0869. A duplicate copy of this sheet is enclosed.

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CI TRILLY

890.00 OP

Dated: September 19, 2001

Respectfully submitted,

Reg. No. 33,407

Bill Kennedy

Registration No. 33,407

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